ISO 21760-1:2019 (E)

Adhesives for organic electronic devices — Determination of water vapour transmission rate — Part 1: Adhesive film preparation methods

Contents

Foreword

1 Scope

2 Normative references

3 Terms and definitions

4 Principle

5 Test specimens

- 5.1 Substrate for non-self-supporting adhesives
- 5.2 Preparation of test specimens
- 5.2.1 Preparation of non-self-supporting adhesives on a substrate
- 5.2.2 Test specimen
- 5.2.3 Number of specimens

6 Conditioning

7 Determination of the thickness of the adhesive

- 7.1 General
- 7.2 Determination of the thickness of the adhesives by calculation
- 7.3 Determination of the thickness of the adhesive by optical, mechanical or other suitable methods

8 Test methods

9 Procedure

- 9.1 General
- 9.2 Water vapour transmission rate, WAS, of the substrate plus adhesive film
- 9.3 Water vapour transmission rate, WS, of the substrate

10 Calculation

- 10.1 General
- 10.2 Water vapour transmission rate, WA, of non-self-supporting adhesive films

11 Test condition

12 Test result

13 Precision

14 Test report

Annex A (informative) Spin coating application methods

- A.1 General
- A.2 Apparatus
- A.3 Procedure

Annex B (informative) Blade coating application methods

- B.1 General
- B.2 Apparatus
- B.3 Procedure

Annex C (informative) Spray coating application methods

C.1 General
C.2 Apparatus
C.3 Procedure

Page count: 10